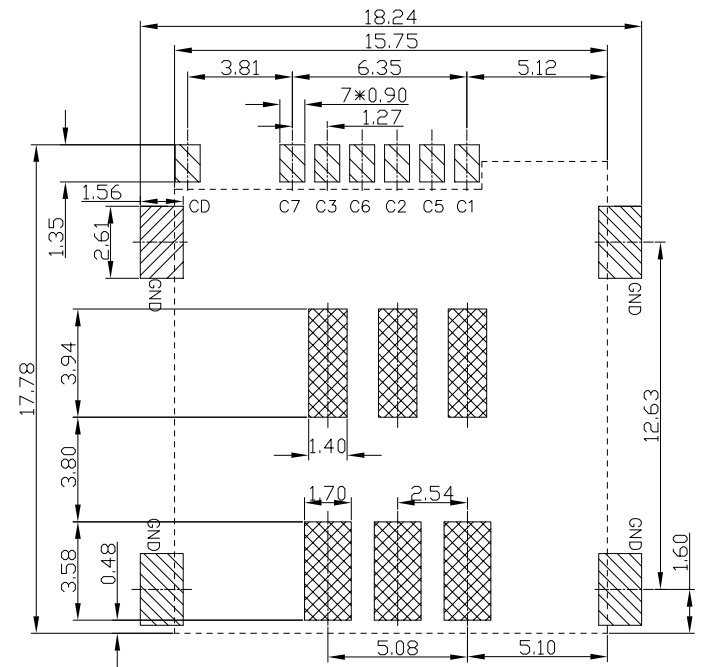
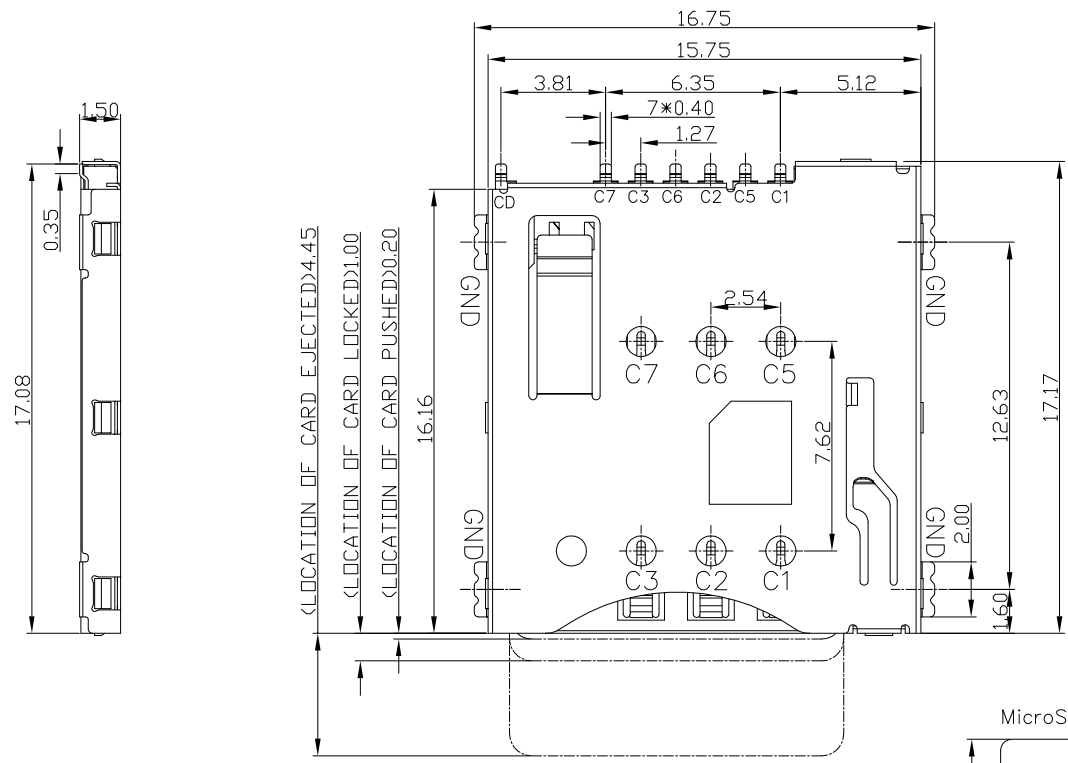
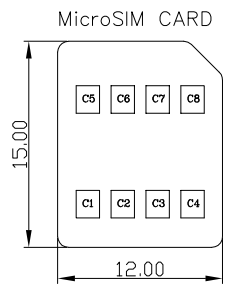
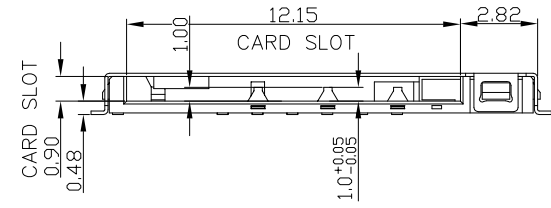


REV NO	MARK	REVISON DESCRIPTION	SIGNATURE	DATE
		NEW DWG		2016-03-12



RECOMMENDED P.C.B LAYOUT
COMPONENT SIDE(TOLERANCE ±0.05)

▨ PAD AREA
▩ KEEP OUT AREA



SCALE 1:2

TECHNICAL CHARACTERISTICS

1.General Characteristics
Dimensions: 15.75LX17.17WX1.50H mm
Weight: Approx 0.4±0.1g
Durability:1500 cycles min.

2.Electrical Characteristics
Contact resistance;
Date Contact:150mΩ max
CD Switch:500mΩ max
Insulation resistance:>1000MΩ/500V DC

3.Solderability
Vapor phase: 215°C,30sec.Max
IR reflow: 250°C,5sec.Max
Manual soldering: 370°C,3sec.Max

4.Environmental Characteristics
Operating temperature: -40°C~+85°C
Operating humidity: 10%~+95%RH

MicroSIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area:Gold plated
4	SHELL	1	Stainless Steel	SMT area:Gold plated
5	COIL SPRING	1	SWP	
6	HEART CAM	1	Hi-temp Thermoplastic	Black UL94V-0
7	CAM PIN	1	Stainless Steel	



深圳市华德共创科技有限公司
Shenzhen Huade co-create Technology Co.,LTD
电话: 0755-27111216 传真: 0755-29940187

-TOLERANCES- UNLESS OTHERWISE SPECIFIED 公差参数表		TITLE: 产品名称: MICRO SIM卡1.5H 6+1防呆	
X.X ±0.30	X.X* ±3°	APPD: 核准:	PART NO: 产品编号: K-DYX-011
X.XX ±0.20	X.XX* ±2°	CHECK: 校对: 王建业	DATE SCALE UNIT CODE NUMBER
X.XXX ±0.10	X.XXX* ±1°	DRAW: 绘图: 黄艳兰	2016-03-12 1:1 mm A001